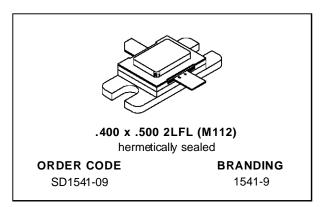
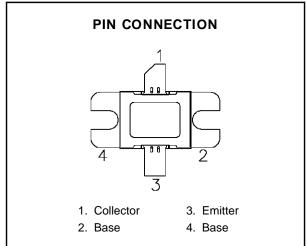


SD1541-09

RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

- DESIGNED FOR HIGH POWER PULSED IFF APPLICATIONS
- 450 WATTS (min.) IFF 1030/1090 MHz
- 7.0 dB MIN. GAIN
- REFRACTORY GOLD METALLIZATION
- BALLASTING AND LOW THERMAL RESISTANCE FOR RELIABILITY AND RUGGEDNESS
- 30:1 LOAD VSWR CAPABILITY AT SPECIFIED OPERATING CONDITIONS
- INPUT MATCHED, COMMON BASE CONFIGURATION





DESCRIPTION

The SD1541-09 is a gold metallized silicon NPN planar transistor. The SD1541-09 is designedfor applications requiring high peak and low duty cycles such as IFF. The SD1541-09 is packaged in a metal/ceramic package with internal input matching, resulting in improved broadband performance and a low thermal resistance.

ABSOLUTE MAXIMUM RATINGS $(T_{case} = 25^{\circ}C)$

| Symbol | Parameter | Value | Unit |
|-------------------|---------------------------|--------------|------|
| Vсво | Collector-Base Voltage | 65 | V |
| V _{CEO} | Collector-Emitter Voltage | 65 | V |
| V _{EBO} | Emitter-Base Voltage | 3.5 | V |
| Ic | Device Current | 22 | А |
| P _{DISS} | Power Dissipation | 1458 | W |
| TJ | Junction Temperature | +200 | °C |
| T _{STG} | Storage Temperature | - 65 to +150 | °C |

THERMAL DATA

| R _{TH(j-c)} Junction-Case Thermal Resistance | 0.12 | °C/W |
|---|------|------|
|---|------|------|

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SD1541-09

ELECTRICAL SPECIFICATIONS (Tcase = 25°C)

STATIC

| Symbol | Test Conditions | Value | | | Unit | | |
|-------------------|-----------------------|-----------------------|------|------|------|-----|----|
| | | Min. | Тур. | Max. | | | |
| ВУсво | I _C = 25mA | $I_E = 0mA$ | | 65 | _ | _ | V |
| BVces | I _C = 50mA | $I_B = 0mA$ | | 65 | _ | _ | V |
| BV _{EBO} | I _E = 10mA | $I_C = 0mA$ | | 3.5 | _ | _ | V |
| I _{CES} | V _{CE} = 50V | $I_E = 0mA$ | | _ | | 25 | mA |
| hfE | V _{CE} = 5V | I _C = .25A | | 5 | _ | 200 | _ |

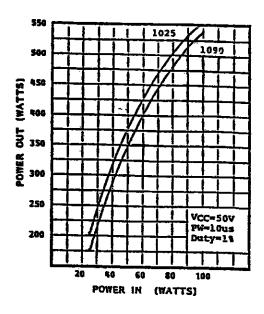
DYNAMIC

| Symbol | Test Conditions | | | | Value | | |
|----------------|-----------------|-----------------|-----------------|------|-------|------|----|
| Symbol | rest Conditions | | Min. | Тур. | Max. | Unit | |
| Pout | f = 1090 MHz | $P_{IN} = 90 W$ | $V_{CE} = 50 V$ | 450 | _ | _ | W |
| G _P | f = 1090 MHz | $P_{IN} = 90 W$ | $V_{CE} = 50 V$ | 7.0 | _ | | dB |

Note: Pulse Width = 10μ Sec, Duty Cycle = 1%

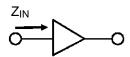
TYPICAL PERFORMANCE

POWER OUTPUT vs POWER INPUT

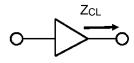


IMPEDANCE DATA



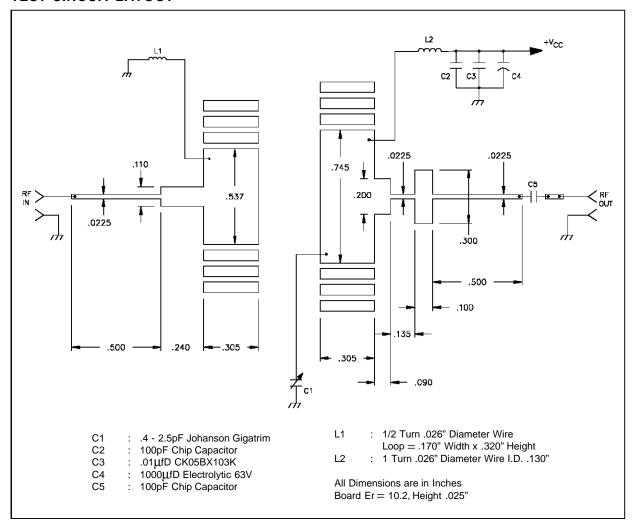


TYPICAL COLLECTOR LOAD IMPEDANCE

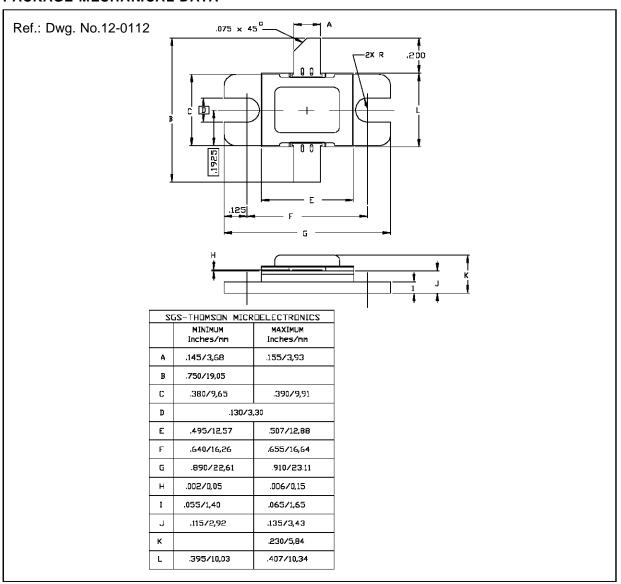


| FREQ. | Z _{IN} (Ω) | Z _{CL} (Ω) |
|----------|---------------------|---------------------|
| 1030 MHz | 1.6 + j 5.1 | 1.1 – j 2.0 |
| 1090 MHz | 2.5 + j 4.7 | 1.2 – j 1.2 |

TEST CIRCUIT LAYOUT



PACKAGE MECHANICAL DATA



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